

05-30-2007

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11/801913
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Armin Walter Bruderlin; Francois Chardavoine; Clint Chua; Gustav Melich

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Sony Corporation

Additional name(s) of conveying party(ies) attached?
 No Yes

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3. Nature of Conveyance:
 Assignment Merger
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Street Address: **1-7-1 Konan, Minato-ku**

City: **Tokyo** Country: **Japan** ZIP: **108-0075**

Execution Date: 5/9/2007, 5/9/2007, 5/10/2007, 5/9/2007

Additional name(s) & address(es) attached? No Yes

4. Application number(s) or patent number(s): This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? No Yes

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Blakely, Sokoloff, Taylor & Zafman LLP

Internal Address: _____

Street Address: 12400 Wilshire Boulevard
7th Floor

City: Los Angeles State: CA ZIP: 90025

Phone Number: (714) 557-3800

Fax Number: (714) 557-3347

E-mail Address: eric_king@bstz.com

6. Total number of applications and patents involved: **1**

7. Total Fee (37 CFR 3.41).....\$ 40.00

Enclosed
 Authorized to be charged to deposit account

8. Deposit Account Number:

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To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Eric T. King

Name of Person Signing

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Recordation Form Cover Sheet - Page 2

**Sony Pictures Entertainment Inc.
10202 W. Washington Blvd.
Culver City, CA 90232
United States**

ASSIGNMENT

WHEREAS, I, as a below named inventor, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

HAIR CACHING OPTIMIZATION TECHNIQUES FOR USE IN A HAIR/FUR PIPELINE, for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-ku, Tokyo, 108-0075, Japan and Sony Pictures Entertainment Inc., a Delaware corporation having a principle place of business at 10202 W. Washington Blvd Culver City, CA 90232 (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefore in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

And I hereby authorize and request my attorney(s) of record in this application to insert the execution date, serial number and filing date of this application in the spaces that follow:

Serial Number: _____, Filing Date: _____.


This assignment is being executed on the date indicated below.

Each Inventor: Please Sign and Date Below:

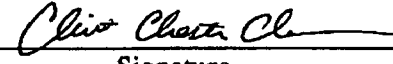
05-09, 2007
Date

Signature


Armin W. Bruderlin
Printed/Typed Name

05/09, 2007
Date

Signature

Francois Chardavoine
Printed/Typed Name

5/10, 2007
Date

Signature

Clint Chua
Printed/Typed Name

5/9, 2007
Date

Signature

Gustav Melich
Printed/Typed Name

_____, 20____
Date

Signature

Printed/Typed Name